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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	46
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f1602ar020sc

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Introduction

The Z8 Encore!® MCU family of products are the first in a line of ZiLOG microcontroller products based upon the new 8-bit eZ8 CPU. The Z8F640x/Z8F480x/Z8F320x/Z8F240x/Z8F160x products are referred to collectively as either Z8 Encore!® or the Z8F640x family. The Z8F640x family of products introduce Flash memory to ZiLOG's extensive line of 8-bit microcontrollers. The Flash in-circuit programming capability allows for faster development time and program changes in the field. The new eZ8 CPU is upward compatible with existing Z8 instructions. The rich peripheral set of the Z8F640x family makes it suitable for a variety of applications including motor control, security systems, home appliances, personal electronic devices, and sensors.

Features

- eZ8 CPU, 20 MHz operation
- 12-channel, 10-bit analog-to-digital converter (ADC)
- 3-channel DMA
- Up to 64KB Flash memory with in-circuit programming capability
- Up to 4KB register RAM
- Serial communication protocols
  - Serial Peripheral Interface
  - I^2C
- Two full-duplex 9-bit UARTs
- 24 interrupts with programmable priority
- Three or four 16-bit timers with capture, compare, and PWM capability
- Single-pin On-Chip Debugger
- Two Infrared Data Association (IrDA)-compliant infrared encoder/decoders integrated with the UARTs
- Watch-Dog Timer (WDT) with internal RC oscillator
- Up to 60 I/O pins
- Voltage Brown-out Protection (VBO)

of the port pin direction (input/output) is passed from the Port A-H Data Direction registers to the alternate function assigned to this pin. Table 11 lists the alternate functions associated with each port pin.

Table 11. Port Alternate Function Mapping

Port	Pin	Mnemonic	Alternate Function Description
Port A	PA0	T0IN	Timer 0 Input
	PA1	T0OUT	Timer 0 Output
	PA2	N/A	No alternate function
	PA3	$\overline{\text{CTS0}}$	UART 0 Clear to Send
	PA4	RXD0 / IRRX0	UART 0 / IrDA 0 Receive Data
	PA5	TXD0 / IRTX0	UART 0 / IrDA 0 Transmit Data
	PA6	SCL	I^2C Clock (automatically open-drain)
	PA7	SDA	I^2C Data (automatically open-drain)
Port B	PB0	ANA0	ADC Analog Input 0
	PB1	ANA1	ADC Analog Input 1
	PB2	ANA2	ADC Analog Input 2
	PB3	ANA3	ADC Analog Input 3
	PB4	ANA4	ADC Analog Input 4
	PB5	ANA5	ADC Analog Input 5
	PB6	ANA6	ADC Analog Input 6
	PB7	ANA7	ADC Analog Input 7
Port C	PC0	T1IN	Timer 1 Input
	PC1	T1OUT	Timer 1 Output
	PC2	$\overline{\text{SS}}$	SPI Slave Select
	PC3	SCK	SPI Serial Clock
	PC4	MOSI	SPI Master Out Slave In
	PC5	MISO	SPI Master In Slave Out
	PC6	T2IN	Timer 2 In
	PC7	T2OUT	Timer 2 Out (not available in 40-pin packages)

Table 22. Interrupt Vectors in Order of Priority

Priority	Program Memory Vector Address	Interrupt Source	Interrupt Assertion Type
Highest	0002h	Reset (not an interrupt)	Not applicable
	0004h	Watch-Dog Timer	Continuous assertion
	0006h	Illegal Instruction Trap (not an interrupt)	Not applicable
	0008h	Timer 2	Single assertion (pulse)
	000Ah	Timer 1	Single assertion (pulse)
	000Ch	Timer 0	Single assertion (pulse)
	000Eh	UART 0 receiver	Continuous assertion
	0010h	UART 0 transmitter	Continuous assertion
	0012h	I^2C	Continuous assertion
	0014h	SPI	Continuous assertion
	0016h	ADC	Single assertion (pulse)
	0018h	Port A7 or Port D7, rising or falling input edge	Single assertion (pulse)
	001Ah	Port A6 or Port D6, rising or falling input edge	Single assertion (pulse)
	001Ch	Port A5 or Port D5, rising or falling input edge	Single assertion (pulse)
	001Eh	Port A4 or Port D4, rising or falling input edge	Single assertion (pulse)
	0020h	Port A3 or Port D3, rising or falling input edge	Single assertion (pulse)
	0022h	Port A2 or Port D2, rising or falling input edge	Single assertion (pulse)
	0024h	Port A1 or Port D1, rising or falling input edge	Single assertion (pulse)
	0026h	Port A0 or Port D0, rising or falling input edge	Single assertion (pulse)
	0028h	Timer 3 *(not available in 40/44-pin packages)*	Single assertion (pulse)
	002Ah	UART 1 receiver	Continuous assertion
	002Ch	UART 1 transmitter	Continuous assertion
	002Eh	DMA	Single assertion (pulse)
	0030h	Port C3, both input edges	Single assertion (pulse)
	0032h	Port C2, both input edges	Single assertion (pulse)
	0034h	Port C1, both input edges	Single assertion (pulse)
Lowest	0036h	Port C0, both input edges	Single assertion (pulse)

Interrupt Request 2 Register

The Interrupt Request 2 (IRQ2) register (Table 25) stores interrupt requests for both vectored and polled interrupts. When a request is presented to the interrupt controller, the corresponding bit in the IRQ2 register becomes 1. If interrupts are globally enabled (vectored interrupts), the interrupt controller passes an interrupt request to the eZ8 CPU. If interrupts are globally disabled (polled interrupts), the eZ8 CPU can read the Interrupt Request 1 register to determine if any interrupt requests are pending.

Table 25. Interrupt Request 2 Register (IRQ2)

BITS	7	6	5	4	3	2	1	0
FIELD	T3I	U1RXI	U1TXI	DMAI	PC3I	PC2I	PC1I	PC0I
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FC6H							

T3I—Timer 3 Interrupt Request
0 = No interrupt request is pending for Timer 3.
1 = An interrupt request from Timer 3 is awaiting service.

U1RXI—UART 1 Receive Interrupt Request
0 = No interrupt request is pending for the UART1 receiver.
1 = An interrupt request from UART1 receiver is awaiting service.

U1TXI—UART 1 Transmit Interrupt Request
0 = No interrupt request is pending for the UART 1 transmitter.
1 = An interrupt request from the UART 1 transmitter is awaiting service.

DMAI—DMA Interrupt Request
0 = No interrupt request is pending for the DMA.
1 = An interrupt request from the DMA is awaiting service.

PC*x*I—Port C Pin *x* Interrupt Request
0 = No interrupt request is pending for GPIO Port C pin *x*.
1 = An interrupt request from GPIO Port C pin *x* is awaiting service.

where *x* indicates the specific GPIO Port C pin number (0 through 3).

set to 2-byte transfers, the temporary holding register for the Timer Reload High Byte is not bypassed.

Table 40. Timer 0-3 Reload High Byte Register (TxRH)

BITS	7	6	5	4	3	2	1	0
FIELD	TRH							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F02H, F0AH, F12H, F1AH							

Table 41. Timer 0-3 Reload Low Byte Register (TxRL)

BITS	7	6	5	4	3	2	1	0
FIELD	TRL							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F03H, F0BH, F13H, F1BH							

TRH and TRL—Timer Reload Register High and Low
These two bytes form the 16-bit Reload value, {TRH[7:0], TRL[7:0]}. This value is used to set the maximum count value which initiates a timer reload to 0001H. In Compare mode, these two byte form the 16-bit Compare value.

information on approximate time-out delays for the minimum and maximum WDT reload values.

Table 45. Watch-Dog Timer Approximate Time-Out Delays

WDT Reload Value	WDT Reload Value	Approximate Time-Out Delay (with 50kHz typical WDT oscillator frequency)	
(Hex)	(Decimal)	Typical	Description
000004	4	80µs	Minimum time-out delay
FFFFFF	16,777,215	335.5s	Maximum time-out delay

Watch-Dog Timer Refresh

When first enabled, the Watch-Dog Timer is loaded with the value in the Watch-Dog Timer Reload registers. The Watch-Dog Timer then counts down to 000000H unless a WDT instruction is executed by the eZ8 CPU. Execution of the WDT instruction causes the downcounter to be reloaded with the WDT Reload value stored in the Watch-Dog Timer Reload registers. Counting resumes following the reload operation.\

When the Z8F640x family device is operating in Debug Mode (via the On-Chip Debugger), the Watch-Dog Timer is continuously refreshed to prevent spurious Watch-Dog Timer time-outs.

Watch-Dog Timer Time-Out Response

The Watch-Dog Timer times out when the counter reaches 000000H. A time-out of the Watch-Dog Timer generates either an interrupt or a Short Reset. The WDT_RES Option Bit determines the time-out response of the Watch-Dog Timer. Refer to the **Option Bits** chapter for information regarding programming of the WDT_RES Option Bit.

WDT Interrupt in Normal Operation

If configured to generate an interrupt when a time-out occurs, the Watch-Dog Timer issues an interrupt request to the interrupt controller and sets the WDT status bit in the Watch-Dog Timer Control register. If interrupts are enabled, the eZ8 CPU responds to the interrupt request by fetching the Watch-Dog Timer interrupt vector and executing code from the vector address. After time-out and interrupt generation, the Watch-Dog Timer counter rolls over to its maximum value of FFFFFH and continues counting. The Watch-Dog Timer counter is not automatically returned to its Reload Value.

WDT Interrupt in Stop Mode

If configured to generate an interrupt when a time-out occurs and the Z8F640x family device is in STOP mode, the Watch-Dog Timer automatically initiates a STOP Mode Recovery and generates an interrupt request. Both the WDT status bit and the STOP bit in the Watch-Dog Timer Control register are set to 1 following WDT time-out in STOP

Transfer Format PHASE Equals Zero

Figure 77 illustrates the timing diagram for an SPI transfer in which PHASE is cleared to 0. The two SCK waveforms show polarity with CLKPOL reset to 0 and with CLKPOL set to one. The diagram may be interpreted as either a Master or Slave timing diagram since the SCK Master-In/Slave-Out (MISO) and Master-Out/Slave-In (MOSI) pins are directly connected between the Master and the Slave.

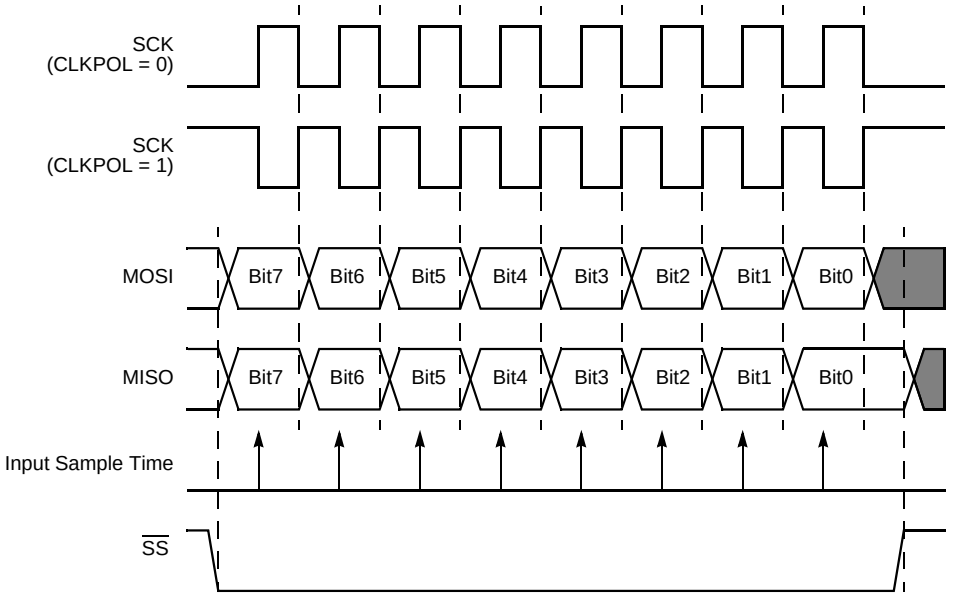


Figure 77. SPI Timing When PHASE is 0

Transfer Format PHASE Equals One

Figure 78 illustrates the timing diagram for an SPI transfer in which PHASE is one. Two waveforms are depicted for SCK, one for CLKPOL reset to 0 and another for CLKPOL set to 1.

limit to the amount of data transferred in one operation. When transmitting data or acknowledging read data from the slave, the SDA signal changes in the middle of the low period of SCL and is sampled in the middle of the high period of SCL.

I²C Interrupts

the I²C Controller contains three sources of interrupts—Transmit, Receive and Not Acknowledge (NAK) interrupts. NAK interrupts occur when a Not Acknowledge is received from the slave or sent by the I²C Controller and the Start or Stop bit is set. This source sets bit 0 and can only be cleared by setting the Start or Stop bit. When this interrupt occurs, the I²C Controller waits until it is cleared before performing any action. In an interrupt service routine, this interrupt must be the first thing polled. Receive interrupts occur when a byte of data has been received by the I²C master. This interrupt is cleared by reading from the I²C Data register. If no action is taken, the I²C Controller waits until this interrupt is cleared before performing any other action.

For Transmit interrupts to occur, the TXI bit must be 1 in the I²C Control register. Transmit interrupts occur under the following conditions when the transmit data register is empty:

- The I²C Controller is idle (not performing an operation).
- The START bit is set and there is no valid data in the I²C Shift or I²C Data register to shift out.
- The first bit of the byte of an address is shifting out and the RD bit of the I²C Status register is deasserted.
- The first bit of a 10-bit address shifts out.
- The first bit of write data shifted out.

Note: Writing to the I²C Data register always clears a Transmit interrupt.

Start and Stop Conditions

The master (I²C) drives all Start and Stop signals and initiates all transactions. To start a transaction, the I²C Controller generates a START condition by pulling the SDA signal low while SCL is high. Then a high-to-low transition occurs on the SDA signal while the clock is High. To complete a transaction, the I²C Controller generates a Stop condition by creating a low-to-high transition of the SDA signal in the middle of the high period of the SCL signal.When the SCL signal is High, the master generates a Start bit by pulling a High SDA signal Low and generates a Stop bit by releasing the SDA signal. The Start and Stop signals are found in the I²C Control register and must be written by software when the Z8F640x family device must begin or end a transaction.

Writing a Transaction with a 7-Bit Address

1. The I²C Controller shifts the I²C Shift register out onto SDA signal.

1. Software writes the I2C Data register with a 7-bit slave address followed by a 1 (read).
2. Software asserts the START bit of the I2C Control register.
3. Software asserts the NAK bit of the I2C Control register so that after the first byte of data has been read by the I2C Controller, a Not Acknowledge is sent to the I2C slave.
4. The I2C Controller sends the START condition.
5. The I2C Controller sends the address and read bit by the SDA signal.
6. The I2C slave sends an Acknowledge by pulling the SDA signal Low during the next high period of SCL.
7. The I2C Controller reads the first byte of data from the I2C slave.
8. The I2C Controller asserts the Receive interrupt.
9. Software responds by reading the I2C Data register.
10. The I2C Controller sends a NAK to the I2C slave.
11. A NAK interrupt is generated by the I2C Controller.
12. Software responds by setting the STOP bit of the I2C Control register.
13. A STOP condition is sent to the I2C slave.

Reading a Transaction with a 10-Bit Address

Figure 82 illustrates the receive format for a 10-bit addressed slave. The shaded regions indicate data transferred from the I2C Controller to slaves and unshaded regions indicate data transferred from the slaves to the I2C Controller.

S	Slave Address 1st 7 bits	W=0	A	Slave address 2nd Byte	A	S	Slave Address 1st 7 bits	R=1	A	Data	A	Data	$\overline{A}$	P

Figure 82. Receive Data Format for a 10-Bit Addressed Slave

The first seven bits transmitted in the first byte are 11110XX. The two bits XX are the two most-significant bits of the 10-bit address. The lowest bit of the first byte transferred is the write signal.

The data transfer format for a receive operation on a 10-bit addressed slave is as follows:

1. Software writes an address 11110B followed by the two address bits and a 0 (write).
2. Software asserts the START bit of the I2C Control register.
3. The I2C Controller sends the Start condition.

– Set CONT to 1 to select continuous conversion.
– Write to VREF to enable or disable the internal voltage reference generator.
– Set CEN to 1 to start the conversions.

3. When the first conversion in continuous operation is complete (after 5129 system clock cycles, plus the 40 cycles for power-up, if necessary), the ADC control logic performs the following operations:
   – CEN resets to 0 to indicate the first conversion is complete. CEN remains 0 for all subsequent conversions in continuous operation.
   – An interrupt request is sent to the Interrupt Controller to indicate the ***first*** conversion is complete. An interrupt request is not sent for subsequent conversions in continuous operation.
4. Thereafter, the ADC writes a new 10-bit data result to {ADCD_H[7:0], ADCD_L[7:6]} every 256 system clock cycles.
5. To disable continuous conversion, clear the CONT bit in the ADC Control register to 0.

DMA Control of the ADC

The Direct Memory Access (DMA) Controller can control operation of the ADC including analog input selection and conversion enable. For more information on the DMA and configuring for ADC operations refer to the **Direct Memory Access Controller** chapter.

ADC Control Register Definitions

ADC Control Register

The ADC Control register selects the analog input channel and initiates the analog-to-digital conversion.

Table 80. ADC Control Register (ADCCTL)

BITS	7	6	5	4	3	2	1	0
FIELD	CEN	Reserved	$\overline{\text{VREF}}$	CONT	ANAIN[3:0]			
RESET	0	0	0	0	0000			
R/W	R/W	R/W	R/W	R/W	R/W			
ADDR	F70H							

CEN—Conversion Enable
0 = Conversion is complete. Writing a 0 produces no effect. The ADC automatically clears

Flash Memory

Overview

The Z8F640x family features up to 64KB (65,536 bytes) of non-volatile Flash memory with read/write/erase capability. The Flash Memory can be programmed and erased in-circuit by either user code or through the On-Chip Debugger.

The Flash memory array is arranged in pages with 512 bytes per page. The 512-byte page is the minimum Flash block size that can be erased. Each page is divided into 8 rows of 64 bytes. The Flash memory also contains a High Sector that can be enabled for writes and erase separately from the rest of the Flash array. The first 2 bytes of the Flash Program memory are used as Option Bits. Refer to the **Option Bits** chapter for more information on their operation.

Table 83 describes the Flash memory configuration for each device in the Z8F640x family. Figure 84 illustrates the Flash memory arrangement.

Table 83. Z8F640x family Flash Memory Configurations

Part Number	Flash Size KB (Bytes)	Flash Pages	Program Memory Addresses	Flash High Sector Size KB (Bytes)	High Sector Addresses
Z8F160x	16 (16,384)	32	0000H - 3FFFH	1 (1024)	3C00H - 3FFFH
Z8F240x	24 (24,576)	48	0000H - 5FFFH	2 (2048)	5800H - 5FFFH
Z8F320x	32 (32,768)	64	0000H - 7FFFH	2 (2048)	7800H - 7FFFH
Z8F480x	48 (49,152)	96	0000H - BFFFH	4 (4096)	B000H - BFFFH
Z8F640x	64 (65,536)	128	0000H - FFFFH	8 (8192)	E000H - FFFFH

On-Chip Debugger

Overview

The Z8F640x family devices have an integrated On-Chip Debugger (OCD) that provides advanced debugging features including:

- Reading and writing of the Register File
- Reading and writing of Program and Data Memory
- Setting of Breakpoints and Watchpoints
- Execution of eZ8 CPU instructions.

Architecture

The On-Chip Debugger consists of four primary functional blocks: transmitter, receiver, auto-baud generator, and debug controller. Figure 86 illustrates the architecture of the On-Chip Debugger

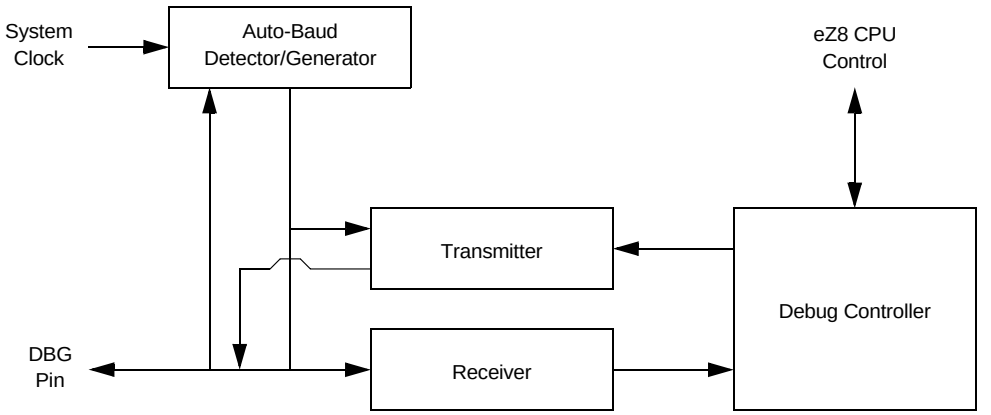


Figure 86. On-Chip Debugger Block Diagram

Table 93. On-Chip Debugger Commands

Debug Command	Command Byte	Enabled when NOT in Debug mode?	Disabled by Read Protect Option Bit
Write Program Memory	0AH	-	Disabled
Read Program Memory	0BH	-	Disabled
Write Data Memory	0CH	-	Yes
Read Data Memory	0DH	-	-
Read Program Memory CRC	0EH	-	-
Reserved	0FH	-	-
Step Instruction	10H	-	Disabled
Stuff Instruction	11H	-	Disabled
Execute Instruction	12H	-	Disabled
Reserved	13H - 1FH	-	-
Write Watchpoint	20H	-	Disabled
Read Watchpoint	21H	-	-
Reserved	22H - FFH	-	-

In the following bulleted list of OCD Commands, data and commands sent from the host to the On-Chip Debugger are identified by '`DBG <-- Command/Data`'. Data sent from the On-Chip Debugger back to the host is identified by '`DBG --> Data`'

- **Read OCD Revision (00H)**—The Read OCD Revision command is used to determine the version of the On-Chip Debugger. If OCD commands are added, removed, or changed, this revision number changes.

```
DBG <-- 00H
DBG --> OCDREV[15:8] (Major revision number)
DBG --> OCDREV[7:0] (Minor revision number)
```

- **Read OCD Status Register (02H)**—The Read OCD Status Register command is used to read the OCDSTAT register.

```
DBG <-- 02H
DBG --> OCDSTAT[7:0]
```

- **Read Runtime Counter (03H)**—The Runtime Counter is used to count Z8 Encore! system clock cycles in between Breakpoints. The 16-bit Runtime Counter counts up from `0000H` and stops at the maximum count of `FFFFH`. The Runtime Counter is overwritten during the Write Memory, Read Memory, Write Register, Read Register, Read Memory CRC, Step Instruction, Stuff Instruction, and Execute Instruction commands.

DC Characteristics

Table 101 lists the DC characteristics of the Z8F640x family devices. All voltages are referenced to V_{SS}, the primary system ground.

Table 101. DC Characteristics

Symbol	Parameter	T_A = -40°C to 105°C			Units	Conditions
		Minimum	Typical	Maximum		
V_{DD}	Supply Voltage	3.0	–	3.6	V	
V_{IL1}	Low Level Input Voltage	-0.3	–	0.3*V_{DD}	V	For all input pins except $\overline{\text{RESET}}$, DBG, and XIN.
V_{IL2}	Low Level Input Voltage	-0.3	–	0.2*V_{DD}	V	For $\overline{\text{RESET}}$, DBG, and XIN.
V_{IH1}	High Level Input Voltage	0.7*V_{DD}	–	5.5	V	Port A, C, D, E, F, and G pins.
V_{IH2}	High Level Input Voltage	0.7*V_{DD}	–	V_{DD}+0.3	V	Port B and H pins.
V_{IH3}	High Level Input Voltage	0.8*V_{DD}	–	V_{DD}+0.3	V	$\overline{\text{RESET}}$, DBG, and XIN pins.
V_{OL1}	Low Level Output Voltage	–	–	0.4	V	V_{DD} = 3.0V; I_{OL} = 2mA High Output Drive disabled.
V_{OH1}	High Level Output Voltage	2.4	–	–	V	V_{DD} = 3.0V; I_{OH} = -2mA High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	V_{DD} = 3.3V; I_{OL} = 20mA High Output Drive enabled. T_A = -40°C to +70°C
V_{OL3}	Low Level Output Voltage	–	–	0.6	V	V_{DD} = 3.3V; I_{OL} = 15mA High Output Drive enabled. T_A = 70°C to +105°C
V_{OH2}	High Level Output Voltage	2.4	–	–	V	V_{DD} = 3.3V; I_{OH} = -20mA High Output Drive enabled. T_A = -40°C to +70°C
V_{OH3}	High Level Output Voltage	2.4	–	–	V	V_{DD} = 3.3V; I_{OH} = -15mA High Output Drive enabled. T_A = 70°C to +105°C
I_{IL}	Input Leakage Current	-5	–	+5	µA	V_{DD} = 3.6V; V_{IN} = VDD or VSS[1]
I_{TL}	Tri-State Leakage Current	-5	–	+5	µA	V_{DD} = 3.6V
C_{PAD}	GPIO Port Pad Capacitance	–	8.0[2]	–	pF	
C_{XIN}	XIN Pad Capacitance	–	8.0[2]	–	pF	
C_{XOUT}	XOUT Pad Capacitance	–	9.5[2]	–	pF	

General Purpose I/O Port Input Data Sample Timing

Figure 93 illustrates timing of the GPIO Port input sampling. The input value on a GPIO Port pin is sampled on the rising edge of the system clock. The Port value is then available to the eZ8 CPU on the second rising clock edge following the change of the Port value.

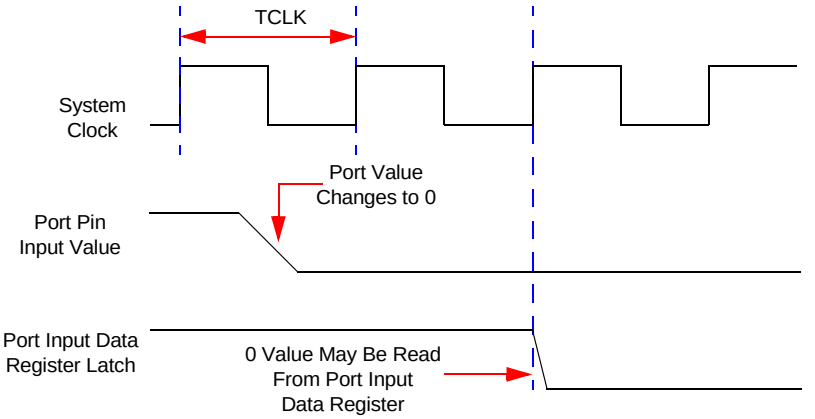


Figure 93. Port Input Sample Timing

Table 107. GPIO Port Input Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
T_{S_PORT}	Port Input Transition to XIN Rise Setup Time (Not pictured)	5	–
T_{H_PORT}	XIN Rise to Port Input Transition Hold Time (Not pictured)	5	–
T_{SMR}	GPIO Port Pin Pulse Width to Insure Stop Mode Recovery (for GPIO Port Pins enabled as SMR sources)	1µs	

SPI Master Mode Timing

Figure 96 and Table 110 provide timing information for SPI Master mode pins. Timing is shown with SCK rising edge used to source MOSI output data, SCK falling edge used to sample MISO input data. Timing on the SS output pin(s) is controlled by software.

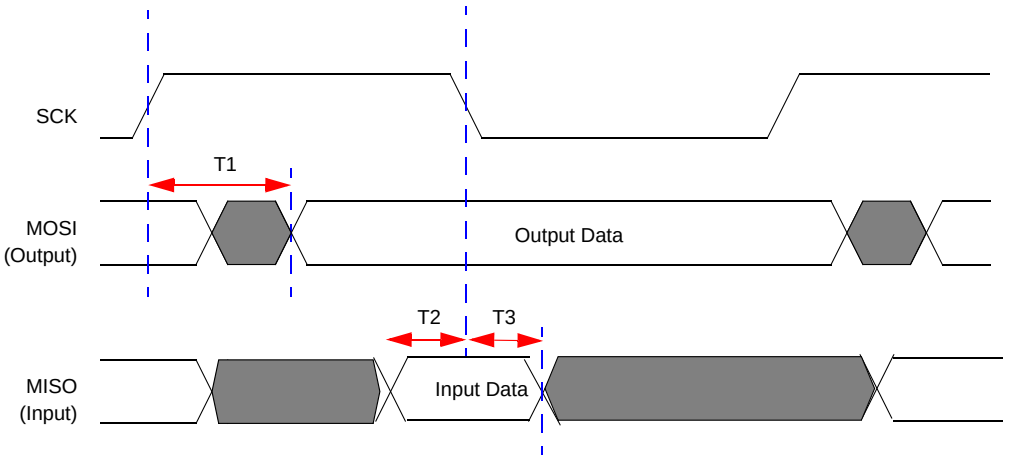


Figure 96. SPI Master Mode Timing

Table 110. SPI Master Mode Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
T_1	SCK Rise to MOSI output Valid Delay	-5	+5
T_2	MISO input to SCK (receive edge) Setup Time	20	
T_3	MISO input to SCK (receive edge) Hold Time	0	

eZ8 CPU Instruction Set

Assembly Language Programming Introduction

The eZ8 CPU assembly language provides a means for writing an application program without having to be concerned with actual memory addresses or machine instruction formats. A program written in assembly language is called a source program. Assembly language allows the use of symbolic addresses to identify memory locations. It also allows mnemonic codes (opcodes and operands) to represent the instructions themselves. The opcodes identify the instruction while the operands represent memory locations, registers, or immediate data values.

Each assembly language program consists of a series of symbolic commands called statements. Each statement can contain labels, operations, operands and comments.

Labels can be assigned to a particular instruction step in a source program. The label identifies that step in the program as an entry point for use by other instructions.

The assembly language also includes assembler directives that supplement the machine instruction. The assembler directives, or pseudo-ops, are not translated into a machine instruction. Rather, the pseudo-ops are interpreted as directives that control or assist the assembly process.

The source program is processed (assembled) by the assembler to obtain a machine language program called the object code. The object code is executed by the eZ8 CPU. An example segment of an assembly language program is detailed in the following example.

Assembly Language Source Program Example

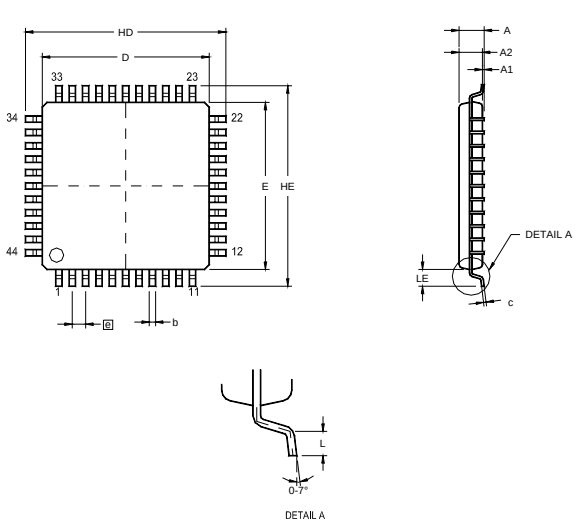
```
JP START          ; Everything after the semicolon is a comment.

START:            ; A label called “START”. The first instruction (JP START) in this
                  ; example causes program execution to jump to the point within the
                  ; program where the START label occurs.

LD R4, R7         ; A Load (LD) instruction with two operands. The first operand,
                  ; Working Register R4, is the destination. The second operand,
                  ; Working Register R7, is the source. The contents of R7 is
                  ; written into R4.

LD 234H, #%01     ; Another Load (LD) instruction with two operands.
                  ; The first operand, Extended Mode Register Address 234H,
                  ; identifies the destination. The second operand, Immediate Data
```

Figure 104 illustrates the 44-pin LQFP (low profile quad flat package) available for the Z8F1601, Z8F2401, Z8F3201, Z8F4801, and Z8F6401 devices.

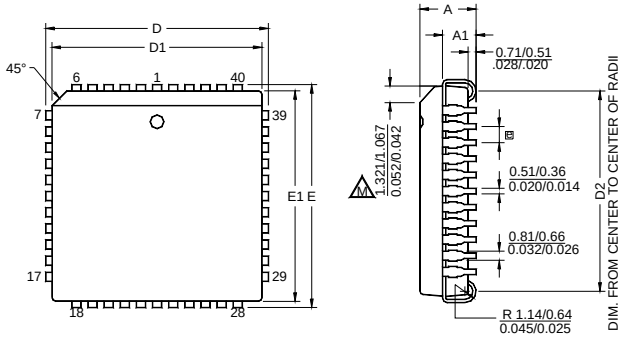


SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	1.40	1.60	0.055	0.063
A1	0.05	0.15	0.002	0.006
A2	1.35	1.45	0.053	0.057
b	0.30	0.45	0.012	0.018
c	0.09	0.20	0.004	0.008
HD	11.75	12.25	0.463	0.482
D	9.90	10.10	0.390	0.398
HE	11.75	12.25	0.463	0.482
E	9.90	10.10	0.390	0.398
e	0.80 BSC		0.031 BSC	
L	0.45	0.75	0.018	0.030
LE	1.00 REF		0.039 REF	

1. CONTROLLING DIMENSIONS : mm
2. MAX. COPLANARITY : .10mm / 0.004"

Figure 104. 44-Lead Low-Profile Quad Flat Package (LQFP)

Figure 105 illustrates the 44-pin PLCC (plastic lead chip carrier) package available for the Z8F1601, Z8F2401, Z8F3201, Z8F4801, and Z8F6401 devices.



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	4.27	4.57	0.168	0.180
A1	2.41	2.92	0.095	0.115
D/E	17.40	17.65	0.685	0.695
D1/E1	16.51	16.66	0.650	0.656
D2	15.24	16.00	0.600	0.630
e	1.27 BSC		0.050 BSC	

NOTES:
1. CONTROLLING DIMENSION : INCH
2. LEADS ARE COPLANAR WITHIN 0.004".
3. DIMENSION : MM / INCH

Figure 105. 44-Lead Plastic Lead Chip Carrier Package (PLCC)

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